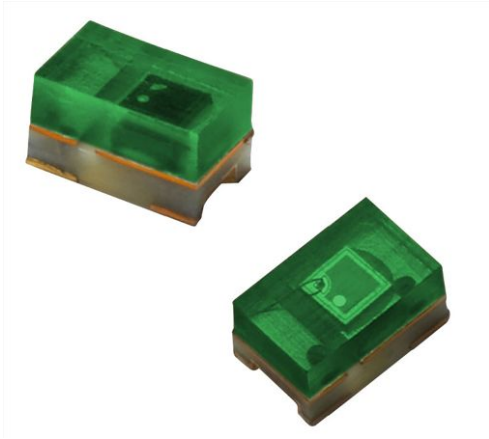


## Ambient Light Sensor in 0805 Package



### FEATURES

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Suppression filter for near infrared radiation
- Angle of half sensitivity:  $\varphi = \pm 60^\circ$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

 AUTOMOTIVE  
GRADE

**RoHS**  
COMPLIANT  
**GREEN**  
(5-2009)

### DESCRIPTION

TEMT6200FX01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 0805 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 550 nm.

### APPLICATIONS

- Automotive sensors
- Ambient light sensor for display backlight dimming in:
  - Mobile phones
  - Notebook computers
  - PDAs
  - Cameras
  - Dashboards

### PRODUCT SUMMARY

COMPONENT	$I_{PCE}$ ( $\mu A$ )	$\varphi$ (deg)	$\lambda_{0.5}$ (nm)
TEMT6200FX01	7.5 to 39	$\pm 60$	450 to 610

#### Note

- Test condition see table "Basic Characteristics"

### ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT6200FX01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel. Label with $I_{PCE}$ group on each reel. Specifications of group A/B/C see table "Type Dedicated Characteristics"	0805

#### Note

- MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ C$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		$V_{CEO}$	6	V
Emitter collector voltage		$V_{ECO}$	1.5	V
Collector current		$I_C$	20	mA
Power dissipation		$P_V$	100	mW
Junction temperature		$T_j$	100	$^\circ C$
Operating temperature range		$T_{amb}$	- 40 to + 100	$^\circ C$
Storage temperature range		$T_{stg}$	- 40 to + 100	$^\circ C$
Soldering temperature	Acc. reflow profile fig. 9	$T_{sd}$	260	$^\circ C$
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	$R_{thJA}$	450	K/W

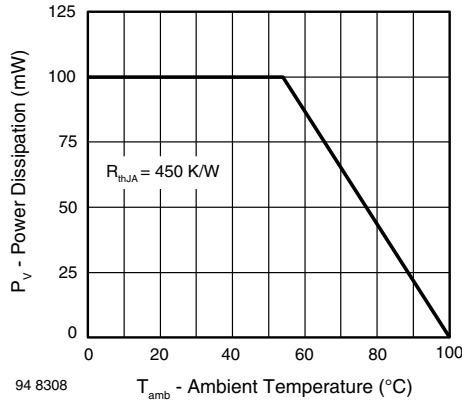


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	$I_C = 0.1\text{ mA}$	$V_{CEO}$	6			V
Collector dark current	$V_{CE} = 5\text{ V}, E = 0\text{ lx}$	$I_{CEO}$		3	50	nA
Collector emitter capacitance	$V_{CE} = 0\text{ V}, f = 1\text{ MHz}, E = 0\text{ lx}$	$C_{CEO}$		16		pF
Photo current	$E_V = 20\text{ lx}, \text{CIE illuminant A}, V_{CE} = 5\text{ V}$	$I_{PCE}$		4.6		$\mu\text{A}$
	$E_V = 100\text{ lx}, \text{CIE illuminant A}, V_{CE} = 5\text{ V}$	$I_{PCE}$	7.5		39	$\mu\text{A}$
Temperature coefficient of $I_{PCE}$	CIE illuminant A	$TK_{I_{PCE}}$		1.18		%/K
	LED, white	$TK_{I_{PCE}}$		0.9		%/K
Angle of half sensitivity		$\varphi$		$\pm 60$		deg
Wavelength of peak sensitivity		$\lambda_p$		550		nm
Range of spectral bandwidth		$\lambda_{0.5}$		450 to 610		nm
Collector emitter saturation voltage	$E_V = 20\text{ lx}, 0.45\text{ }\mu\text{A}$	$V_{CEsat}$		0.1		V

**TYPE DEDICATED CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	BINNED GROUP	SYMBOL	MIN.	MAX.	UNIT
Photo current	$E_V = 100\text{ lx}, \text{CIE illuminant A}, V_{CE} = 5\text{ V}$	A	$I_{PCE}$	7.5	15	$\mu\text{A}$
		B	$I_{PCE}$	12	24	$\mu\text{A}$
		C	$I_{PCE}$	19.5	39	$\mu\text{A}$

**Note**

- Each 3000 piece packing unit will contain a single group. The label on the bag will indicate which binned group is in the bag. A specific group cannot be ordered. Production shipments containing multiple bags will likely include multiple groups. Please design accordingly.

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

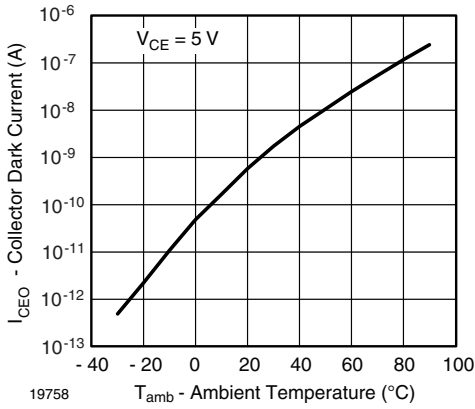


Fig. 2 - Collector Dark Current vs. Ambient Temperature

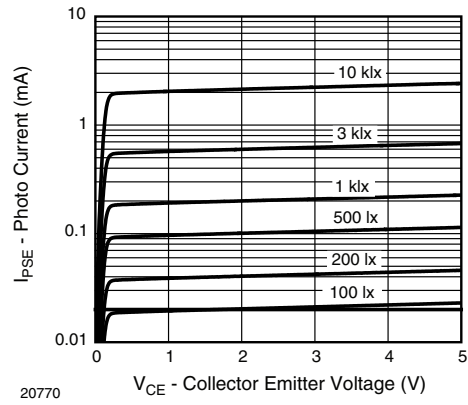


Fig. 5 - Photo Current vs. Collector Emitter Voltage

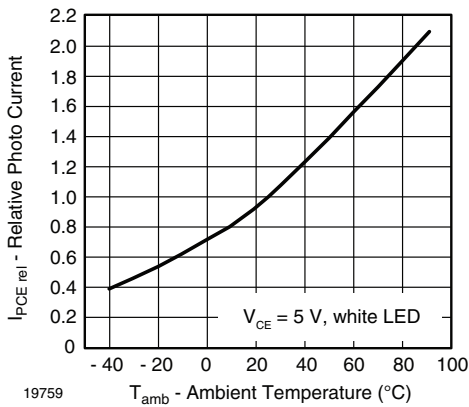


Fig. 3 - Relative Photo Current vs. Ambient Temperature

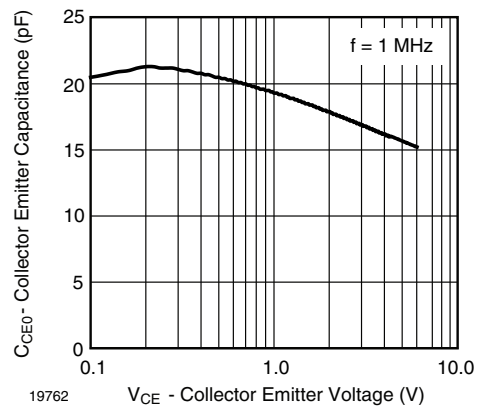


Fig. 6 - Collector Emitter Capacitance vs. Collector Emitter Voltage

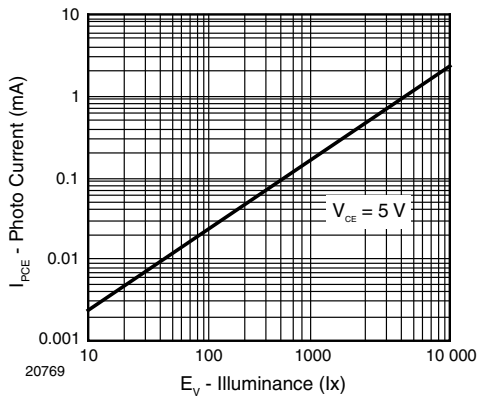


Fig. 4 - Photo Current vs. Illuminance

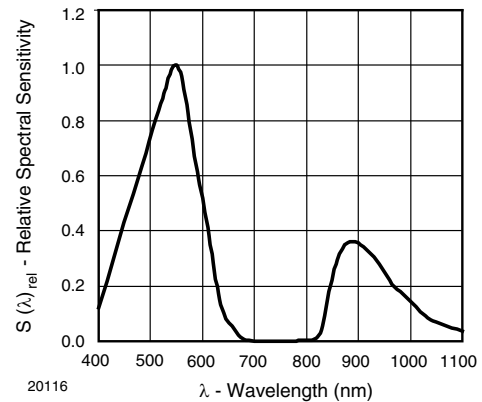


Fig. 7 - Relative Spectral Sensitivity vs. Wavelength

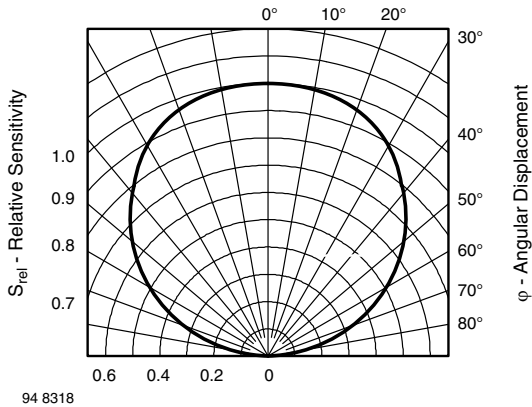


Fig. 8 - Relative Radiant Sensitivity vs. Angular Displacement

**REFLOW SOLDER PROFILE**

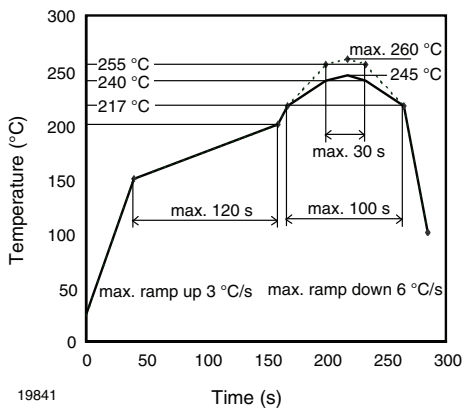


Fig. 9 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

**DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

**FLOOR LIFE**

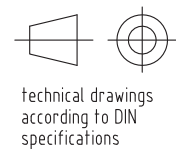
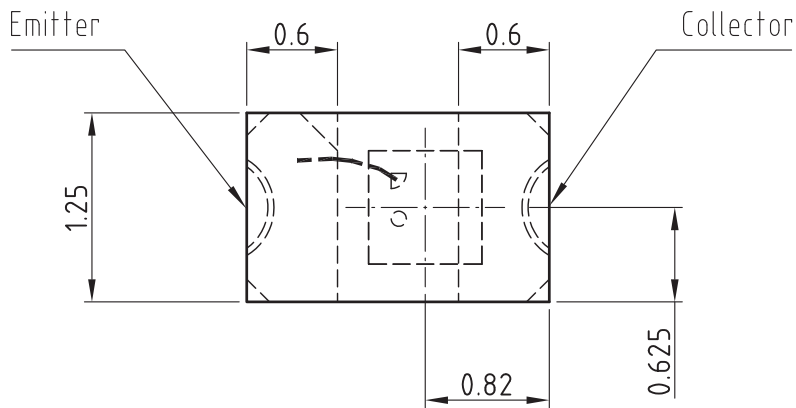
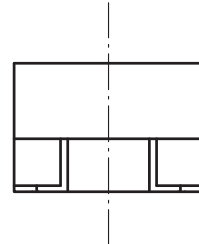
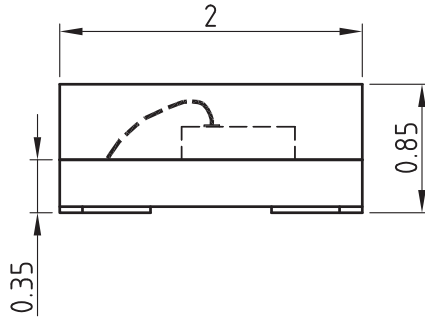
Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:  
 Moisture sensitivity: level 3  
 Floor life: 168 h  
 Conditions:  $T_{amb} < 30\text{ °C}$ ,  $RH < 60\%$

**DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at  $40\text{ °C} (+ 5\text{ °C})$ ,  $RH < 5\%$ .

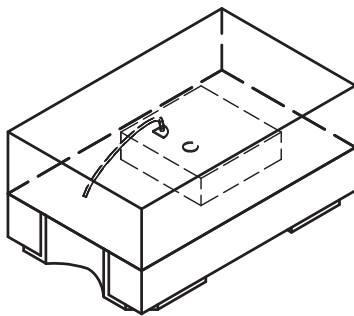


PACKAGE DIMENSIONS in millimeters

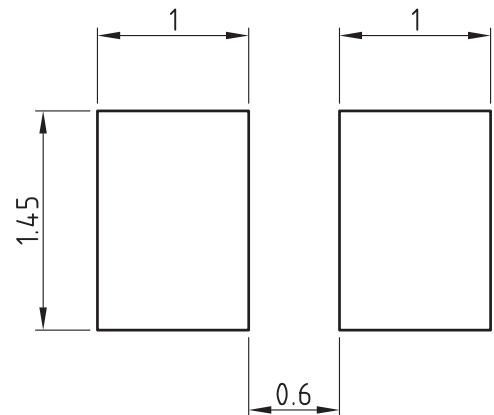


technical drawings according to DIN specifications

Not indicated tolerances ±0.1



Recommended solder pad Footprint



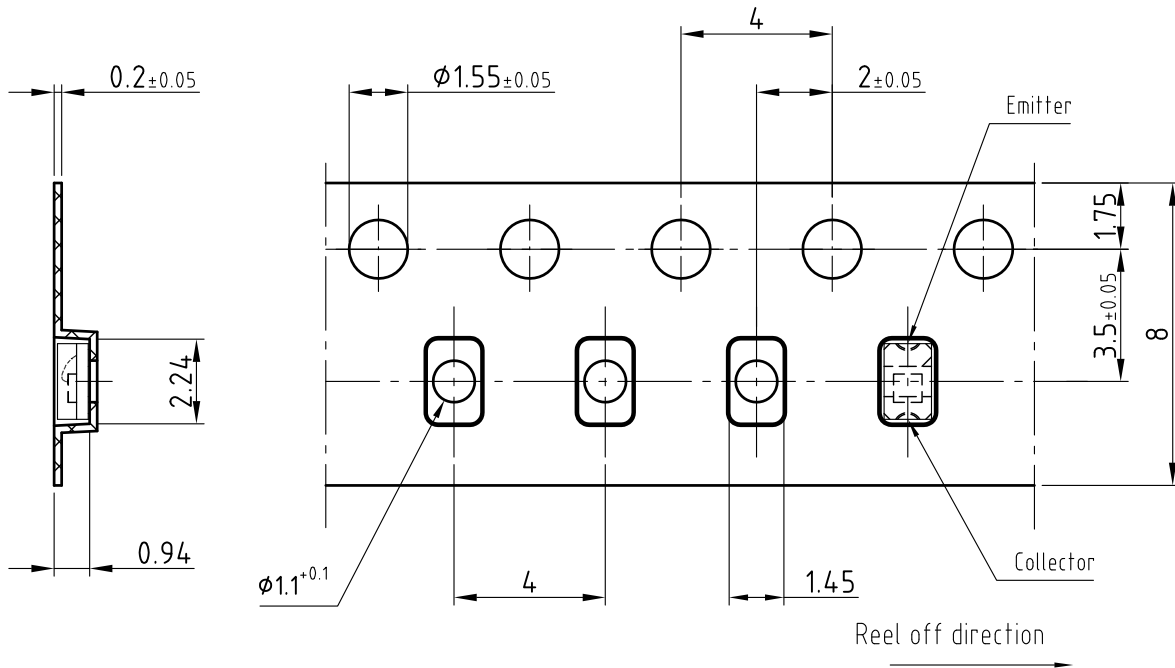
Drawing-No.: 6.541-5063.01-4

Issue: 3; 23.02.07

19757



BLISTER TAPE DIMENSIONS in millimeters



Drawing-No.: 9.700-5310.01-4  
 Issue: 2; 14.08.07  
 20690

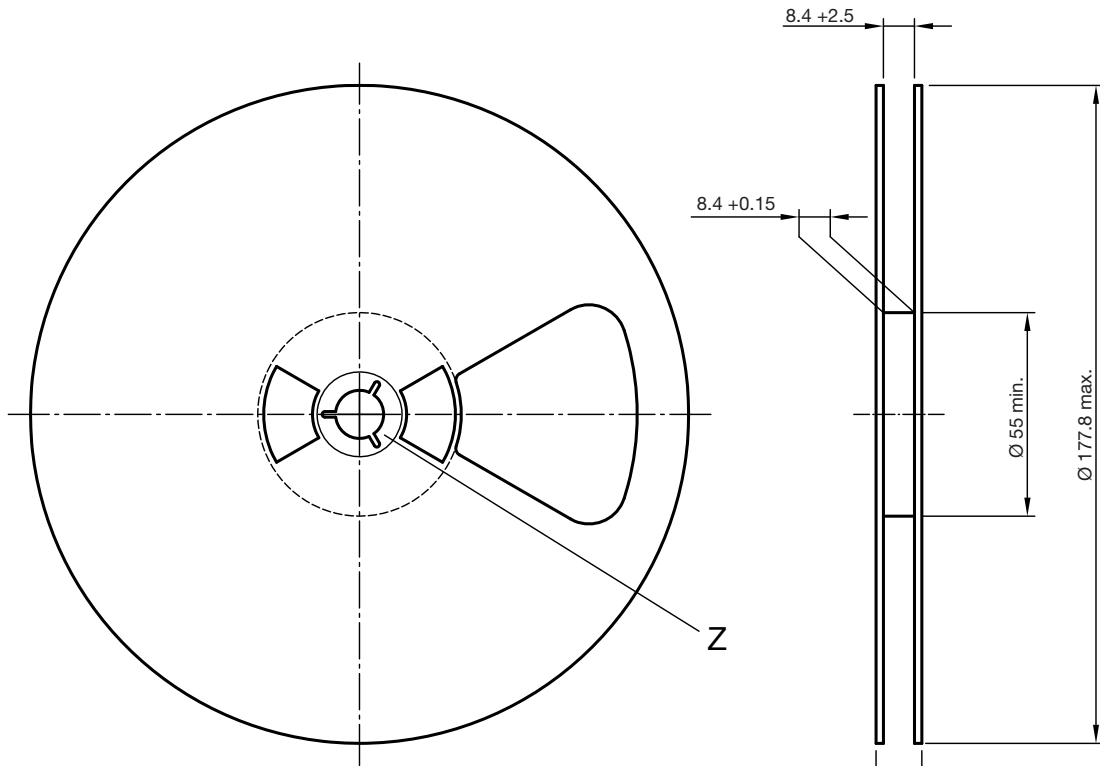
Not indicated tolerances ±0.1

Quantity per reel: 3000 pcs

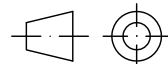
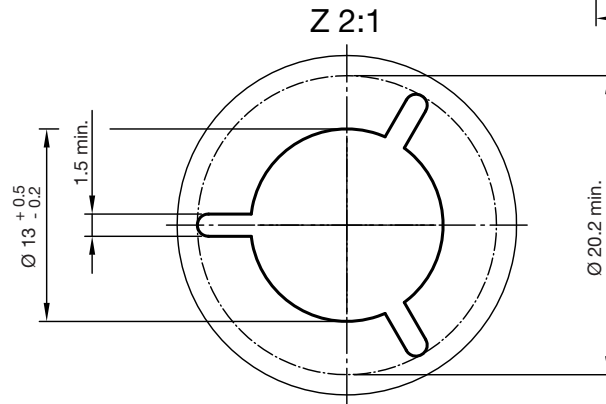
technical drawings  
 according to DIN  
 specifications



### REEL DIMENSIONS in millimeters



Form of the leave open of the wheel is supplier specific.



technical drawings according to DIN specifications

Drawing-No.: 9.800-5096.01-4

Issue: 2; 26.04.10

20875



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

## Material Category Policy

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.**

**Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.**

**Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.**